



PATENT  
8013-1147

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Hirokazu HONDA

Conf. 7187

Application No. 09/678,609

Group 2822

Filed October 4, 2000

Examiner D. Graybill

MULTILAYER INTERCONNECTION BOARD,  
SEMICONDUCTOR DEVICE HAVING THE  
SAME, AND METHOD OF FORMING THE  
SAME AS WELL AS METHOD OF MOUNTING  
THE SEMICONDUCTOR CHIP ON THE  
INTERCONNECTION BOARD

PETITION FOR EXTENSION OF TIME

Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

October 25, 2006

Sir:

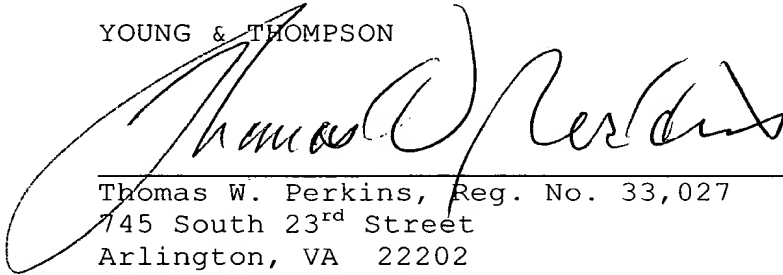
The undersigned hereby petitions for an extension of time to respond to the Official Action of July 12, 2006 for one month to November 12, 2006.

Please charge the extension fee of \$120 to Deposit Account No. 25-0120. If this fee is insufficient, the Patent Office is hereby authorized to charge any additional extension fee to Deposit Account No. 25-0120. A duplicate copy of this sheet is enclosed.

A responsive paper is filed herewith.

Respectfully submitted,

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